



FQD5N20L / FQU5N20L

200V LOGIC N-Channel MOSFET

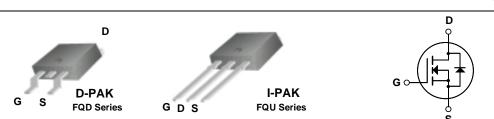
General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology is especially tailored to minimize resistance, provide superior switching on-state performance, and withstand high energy pulse in the avalanche and commutation modes. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supplies, and motor control.

Features

- 3.8A, 200V, $R_{DS(on)} = 1.2\Omega$ @V_{GS} = 10 V Low gate charge (typical 4.8 nC)
- Low Crss (typical 6.0 pF)
- · Fast switching
- 100% avalanche tested
- · Improved dv/dt capability
- Low level gate drive requirement allowing direct operation from logic drivers
- RoHS Compliant



Absolute Maximum Ratings $T_C = 25$ °C unless otherwise noted

Symbol	Parameter		FQD5N20L / FQU5N20L	Units
V _{DSS}	Drain-Source Voltage		200	V
I _D	Drain Current - Continuous (T _C = 25°C)	3.8	Α
	- Continuous (T _C = 100°C)		2.4	А
I _{DM}	Drain Current - Pulsed	(Note 1)	15.2	А
V _{GSS}	Gate-Source Voltage		± 20	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	60	mJ
I _{AR}	Avalanche Current	(Note 1)	3.8	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	3.7	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns
P_{D}	Power Dissipation (T _A = 25°C) *		2.5	W
	Power Dissipation (T _C = 25°C)		37	W
	- Derate above 25°C		0.29	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		3.4	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		110	°C/W

* When mounted on the minimum pad size recommended (PCB Mount)

Symbol	Parameter	Test Conditions	i	Min	Тур	Max	Units
Off Cha	aracteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		200			V
ΔBV_{DSS} / ΔT_{J}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, Referenced	to 25°C		0.18		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 200 V, V _{GS} = 0 V				1	μΑ
		V _{DS} = 160 V, T _C = 125°C		-		10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V				100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$		-		-100	nA
On Cha	racteristics						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1.0		2.0	V
R _{DS(on)}	Static Drain-Source	V _{GS} = 10 V, I _D = 1.9 A			0.94	1.2	-
D3(0H)	On-Resistance	$V_{GS} = 5 \text{ V}, I_D = 1.9 \text{ A}$	(Note 4)		0.98	1.25	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 30 V, I _D = 1.9 A			3.35		S
	ic Characteristics				250	325	n.E
Ciss	Input Capacitance Output Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			40	325 50	pF
C _{oss}	Reverse Transfer Capacitance				6	8	pF pF
orss	Neverse Hansier Capacitance				- 0	0	рі
Switchi	ing Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 100 V, I_{D} = 4.5 A, R_{G} = 25 Ω (Note 4, 5)	-	9	25	ns	
t _r	Turn-On Rise Time				90	190	ns
$t_{d(off)}$	Turn-Off Delay Time		(Note 4, 5)		15	40	ns
t _f	Turn-Off Fall Time				50	110	ns
Q_g	Total Gate Charge	$V_{DS} = 160 \text{ V}, I_{D} = 4.5 \text{ A},$			4.8	6.2	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 5 V (Note 4, 5)			1.2		nC
Q_{gd}	Gate-Drain Charge				2.4		nC
Drain-S	Source Diode Characteristics ar	nd Maximum Ratings	6				
Is	Maximum Continuous Drain-Source Diode Forward Current				3.8	Α	
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				15.2	Α	
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 3.8 \text{ A}$				1.5	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{S} = 4.5 \text{ A},$	(Note 4)		95		ns
Q _{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/μs			0.3		μC

- $\label{eq:Notes:Notes:} \textbf{Notes:} \\ 1. \ \text{Repetitive Rating}: \ \text{Pulse width limited by maximum junction temperature} \\ 2. \ L = 6.2 \text{mH}, \ l_{AS} = 3.8 \text{A}, \ V_{DD} = 50 \text{V}, \ R_G = 25 \ \Omega, \ \text{Starting} \quad T_J = 25 ^{\circ} \text{C} \\ 3. \ l_{SD} \le 4.5 \text{A}, \ \text{di/dt} \le 300 \text{A/µs}, \ V_{DD} \le B \text{V}_{DS}, \ \text{Starting} \quad T_J = 25 ^{\circ} \text{C} \\ 4. \ \text{Pulse Test}: \ \text{Pulse width} \le 300 \text{Qus}, \ \text{Duty cycle} \le 2\% \\ 5. \ \text{Essentially independent of operating temperature} \\ \end{aligned}$

Typical Characteristics

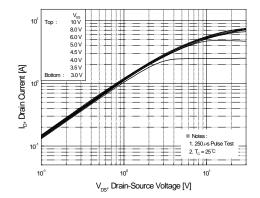


Figure 1. On-Region Characteristics

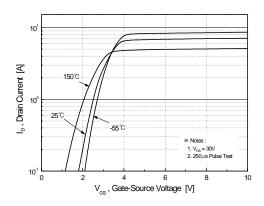


Figure 2. Transfer Characteristics

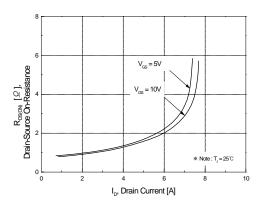


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

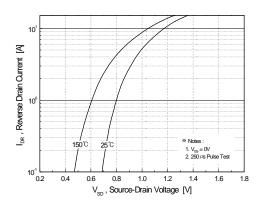


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

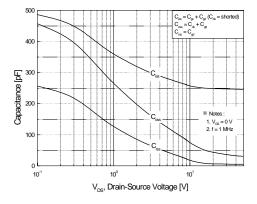


Figure 5. Capacitance Characteristics

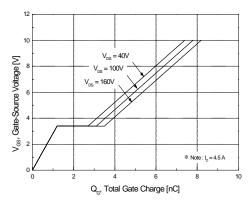
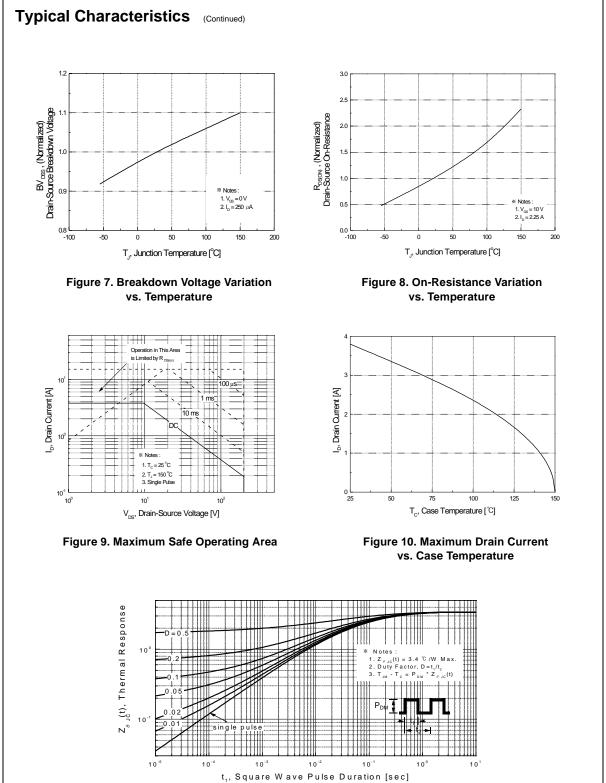


Figure 6. Gate Charge Characteristics

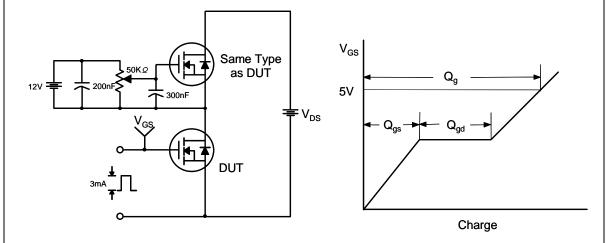
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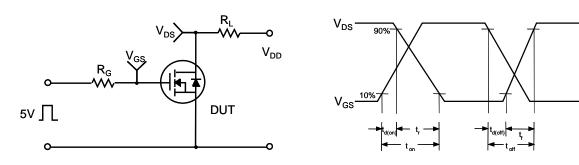
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Figure 11. Transient Thermal Response Curve

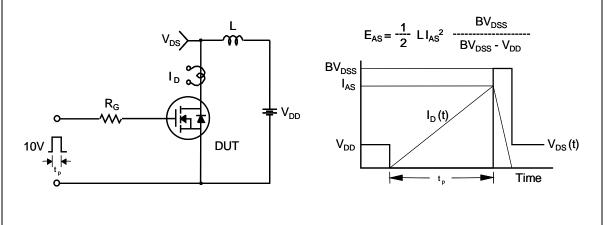
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

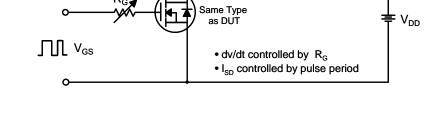


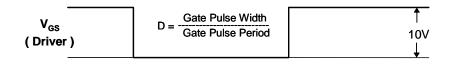
Unclamped Inductive Switching Test Circuit & Waveforms

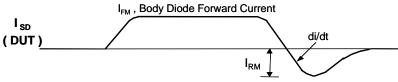


Peak Diode Recovery dv/dt Test Circuit & Waveforms DUT VDS USD VDS

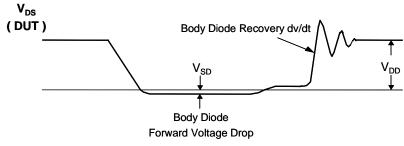
Driver





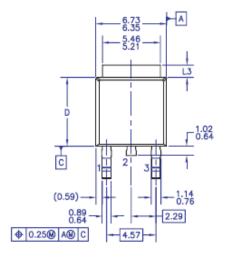


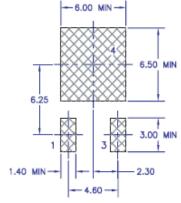
Body Diode Reverse Current

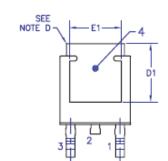


Mechanical Dimensions

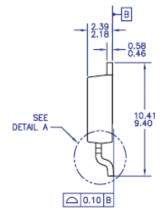
D - PAK

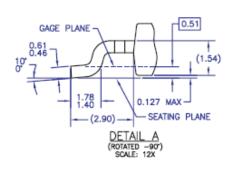






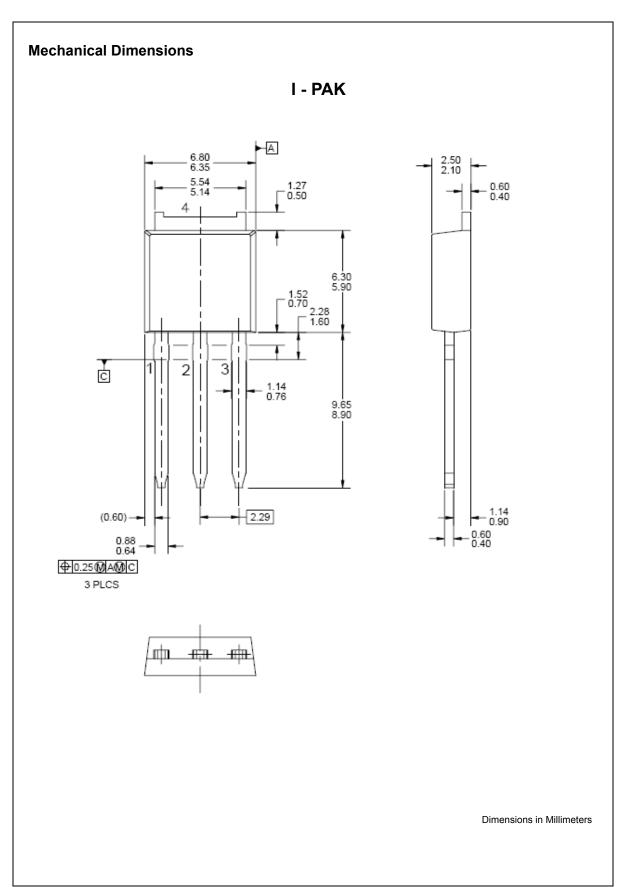






Dimensions in Millimeters

Rev. A3, October 2008







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